BRIGHT VIEW
ELECTRONICS CO.,LTD

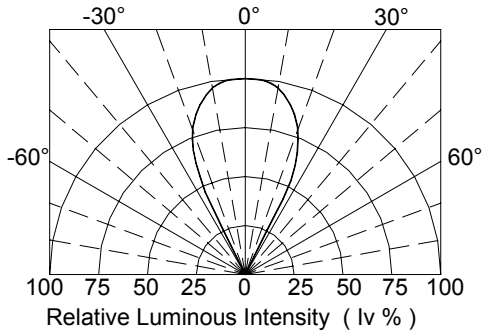
ULTRA BRIGHTNESS LED LAMP

BVU-3X16WI4

DESCRIPTION

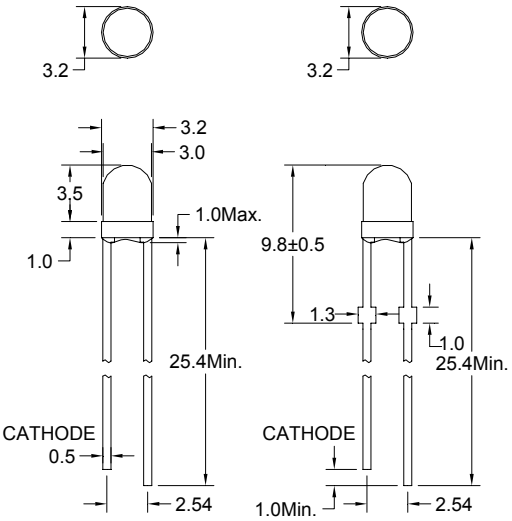
Dice Material : GaN Blue
Light Color : White Color
Lens Color : Water Transparent
Stand-Off P/N : BVU-3X16WI4 R

RADIATION PATTERN



Relative Luminous Intensity (Iv %)

PACKAGE CONFIGURATION



Tolerance ± 0.25 ㎜

ABSOLUTE MAXIMUM RATINGS AT Ta = 25 ℃

PARAMETER	MAX.	UNIT
Power Dissipation (P_D)	120	mW
Continuous Forward Current (I_F)	30	mA
Peak Forward Current (1/10 Duty Cycle , 10ms Pulse Width) (I_{FP})	100	mA
Reverse Voltage (V_R)	5	V
Derating Linear From 25 ℃	0.4	mA/℃
Operating Temperature Range (Topr)	－30 ℃ to ＋ 85 ℃	
Storage Temperature Range (Tstg)	－40 ℃ to ＋ 100 ℃	
Lead Solder Temperature 1.6 mm Below Package 260 ℃ for 5 seconds (Tsld)		

ELECTRICAL / OPTICAL CHARACTERISTICS AT Ta = 25 ℃

SYMBOL	PARAMETER	TEST COND.	MIN.	TYP.	MAX.	UNIT
V_F	Forward Voltage	I_F = 20 mA		3.2	4.0	V
I_R	Reverse Current	V_R = 5V			10	μA
2θ1/2	Viewing Angle	I_F = 20 mA		55		Deg
I_V	Luminous Intensity	I_F = 20 mA	2800	3600		mcd

BIN GRADE LIMITS (IF=20 mA) LUMINOUS INTENSITY / mcd

Bin	N	O	P	Q
Min.	2800	3600	4650	6000
Max.	3600	4650	6000	7800

Tolerance ± 15%mcd

Please contact our sales department for more information.

BIN GRADE LIMITS (IF=20 mA) CHROMATICITY COORDINATESL

WA1	x	0.260	0.260	0.275	0.275	WC1	x	0.320	0.320	0.335	0.335
	y	0.240	0.280	0.300	0.260		y	0.330	0.370	0.390	0.350
WA2	x	0.275	0.275	0.290	0.290	WC2	x	0.335	0.335	0.350	0.350
	y	0.260	0.300	0.320	0.280		y	0.350	0.390	0.410	0.370
WB1	x	0.290	0.290	0.305	0.305	WD1	x	0.350	0.350	0.365	0.365
	y	0.280	0.320	0.345	0.305		y	0.370	0.410	0.430	0.390
WB2	x	0.305	0.305	0.320	0.320	WD2	x	0.365	0.365	0.380	0.380
	y	0.305	0.345	0.370	0.330		y	0.390	0.430	0.450	0.410

*Bright View reserves the rights to alter specifications and remove availability of products at any time without notice.
*Dominant Wavelength, λd is according to CIE Chromaticity Diagram base on color of lamps.
*θ1/2 is the off-axis angle where the luminous intensity is one half the on-axis intensity.
*These products are sensitive to static electricity. Caution must be taken strictly to avoid static electricity.

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TYPICAL ELECTRICAL / OPTICAL CHARACTERISTIC CURVES

FIG. 1 Forward Current vs. Forward Voltage (Ta = 25 °C)

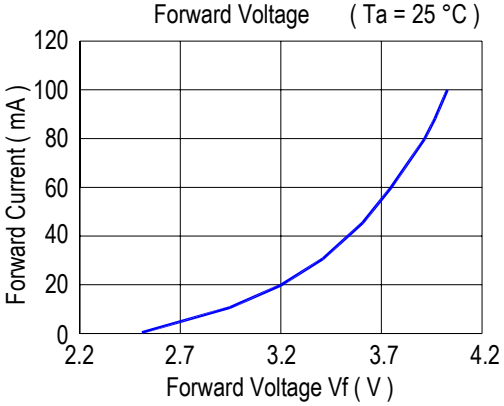


FIG. 2 Relative Luminous Intensity vs. Forward Current (Ta = 25 °C)

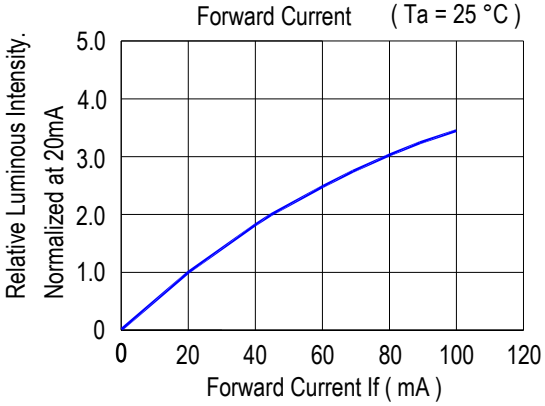


FIG. 3 Relative Forward Voltage vs. Temperature

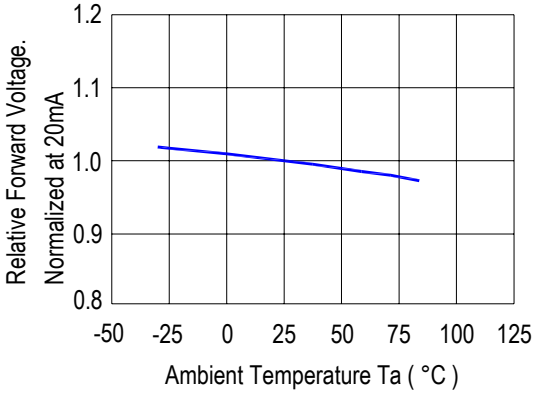


FIG. 4 Relative Luminous Intensity vs. Temperature

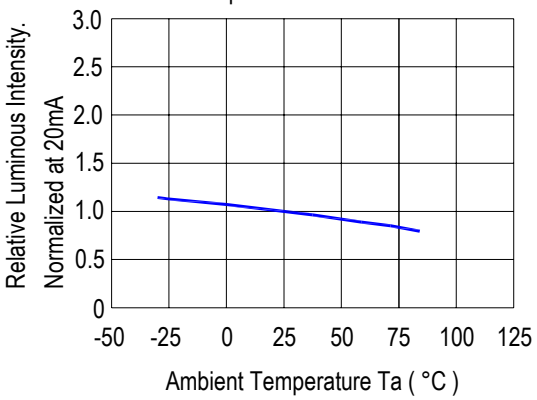


FIG. 5 Relative Intensity vs. Wavelength (λp) (If =20mA , Ta = 25 °C)

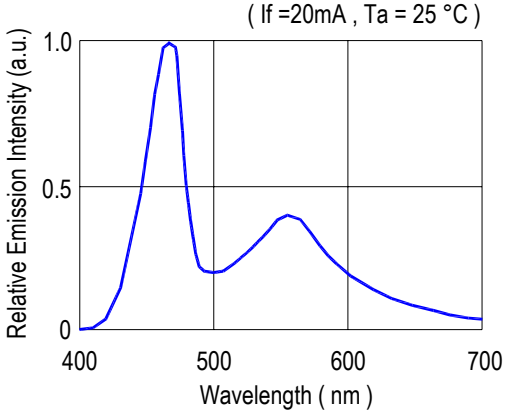
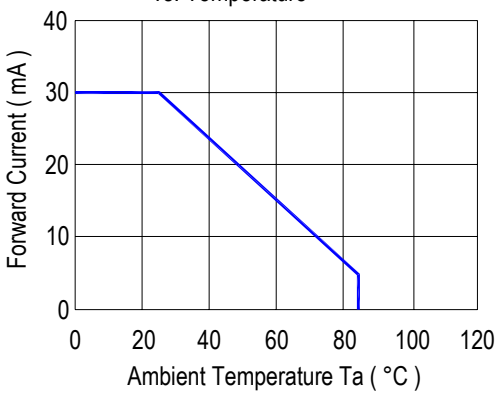


FIG. 6 Maximum Forward Current vs. Temperature



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CAUTION FOR CLASS 1 ESD (MACHINE MODE)

Gallium Nitride (GaN) based light emitting diodes (LEDs) are extremely sensitive to electrostatic discharge (ESD). Users are strongly recommended to take necessary meter to test the static and avoid ESD when handing these products.

Bright View's BA, GN, WI series products are GaN based materials and are classified as "Class 1",(ESD endurance 50V or lower), any manufacturing site or workstation where GaN devices are handled should be rated and controlled at 50V or below.

Proper grounding of products or machines (via 1MΩ), using static dissipative mats, static dissipative containers, static dissipative working uniferms and shoes are considered to be effective against ESD.

An ionizer is recommended in the facility or environment where ESD may be generated easily, and soldering iron with a grounded tip is also recommended.

To install a protection device in the LED circuit to ensure the surge current and voltage not exceeding the max rating during on/off swithing.

When inspecting the final products in which LEDs are assembled, it is recommended to check whether the assembled LEDs are damaged by ESD or not. It is simple to find damaged LEDs by light-on or a VF test at lower current (below 1mA is recommended).

ESD damaged LEDs will show some unusual characteristics such as the remarkable increasing of leak current, the forward voltage become lower, or the LEDs do not light on at the low current.

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Apply to LAMP(DIP) series.

Description:

(1) Manual soldering (Solder Iron)

(1.1) Temperature at tip of the iron: 300°C Max.

(1.2) It's banned to load any stress on the resin during soldering.

(1.3) Soldering time: 3 sec. Max.(one time only)

(1.4) Leave 3mm of minimum distance from the base of epoxy.

(2) Dip Soldering(Wave soldering-Solder Bath)

(2.1) Leave 3mm of minimum distance from the base of the epoxy.
Soldering beyond the base of the tie bar(stand off) is recommended.

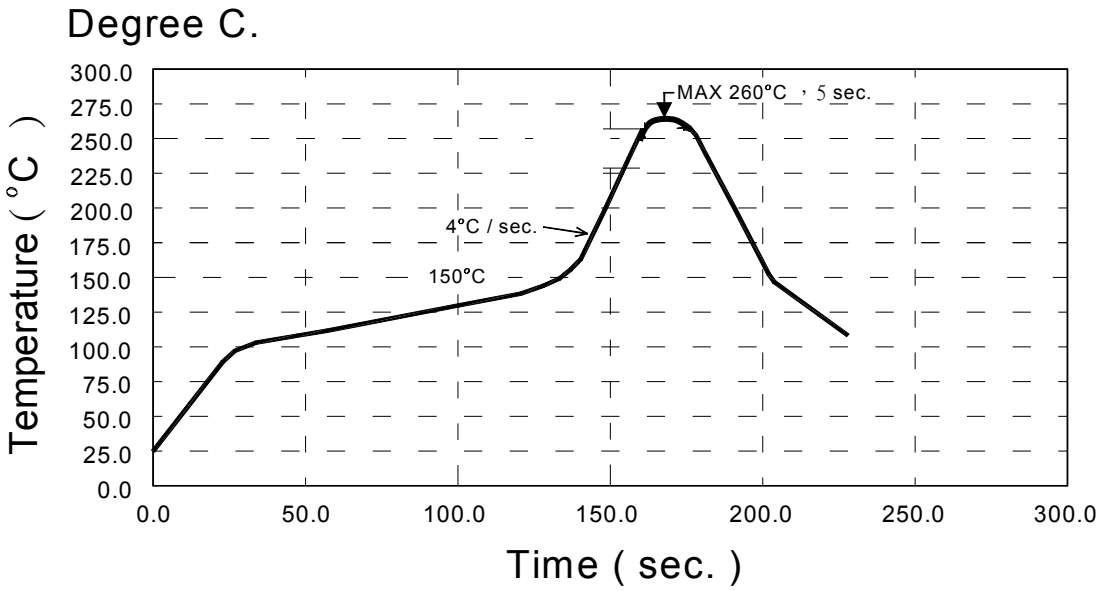
(2.2) When soldering, do not put stress on the LEDs during heating.

(2.3) Cutting the leadframes at high temperatures may cause LED failure.

(2.4) Never take next process until the component is cooled down to room temperature after reflow.

(2.5) After soldering, do not warp the circuit board.

(2.6) The recommended dip soldering profile is the following:



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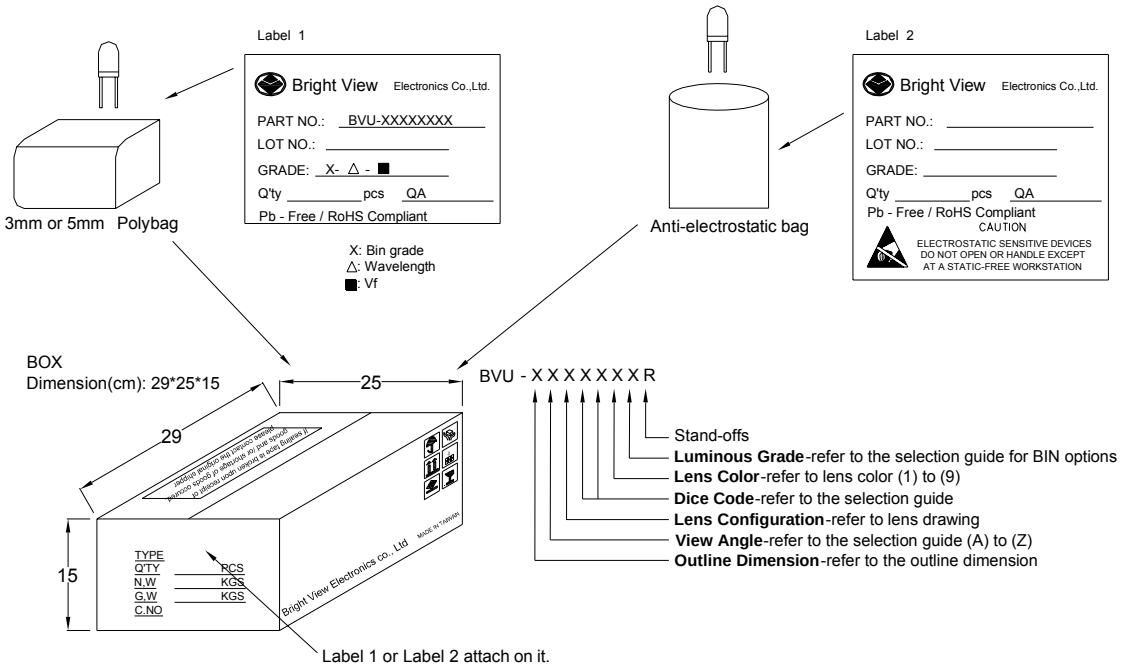
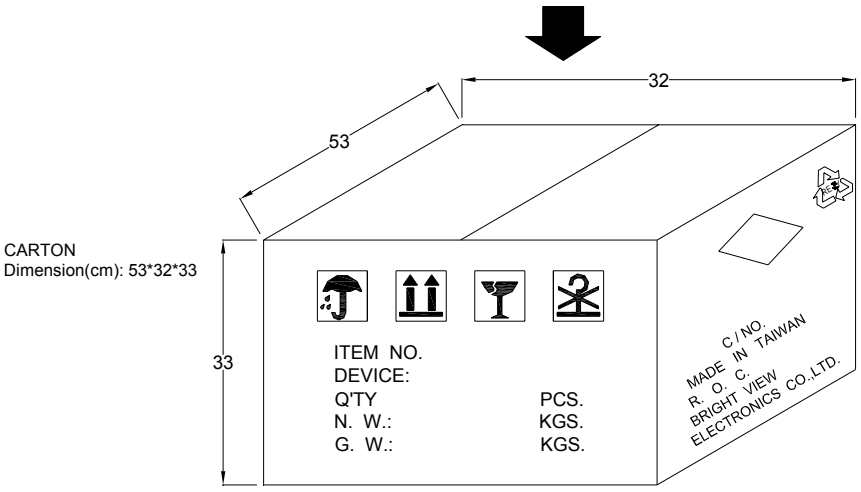


Device	Q'ty / Polybag (pcs)	Polybag / Box A	Fig.
5mm(T-1 3/4)	1000pcs	14 bags	Label 1
3mm(T-1)	1000pcs	20 bags	Label 1
Blue / Green / White	500pcs	18 bags	Label 2



4 Boxes / Carton

5mm : 56,000pcs

3mm : 80,000pcs

Blue / Green / White : 36,000pcs